A semi-analytical model for predicting stress evolution in multilayer coating systems during thermal cycling

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PII: S0020-7403(17)31822-2
DOI: 10.1016/j.ijmecsci.2017.11.010
Reference: MS 4026

To appear in: *International Journal of Mechanical Sciences*

Received date: 5 July 2017
Revised date: 19 October 2017
Accepted date: 7 November 2017

Please cite this article as: Biao Li , Xueling Fan , Kun Zhou , Tiejun Wang , A semi-analytical model for predicting stress evolution in multilayer coating systems during thermal cycling, *International Journal of Mechanical Sciences* (2017), doi: 10.1016/j.ijmecsci.2017.11.010

Highlights

- A semi-analytical model is proposed to predict stress evolution in coating systems.
- Thermal gradient, oxide growth and creep relaxation are considered in the model.
- Creep plays key role in determining stress evolution during thermal cycling.
- Creep in the oxide is beneficial to the durability of the coating system.